

ZXMP3A16N8

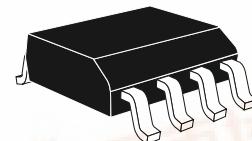
30V P-CHANNEL ENHANCEMENT MODE MOSFET

SUMMARY

$V_{(BR)DSS} = -30V$; $R_{DS(ON)} = 0.040\Omega$; $I_D = -6.7A$

DESCRIPTION

This new generation of TRENCH MOSFETs from Zetex utilizes a unique structure that combines the benefits of low on-resistance with fast switching speed. This makes them ideal for high efficiency, low voltage, power management applications.



SO8

FEATURES

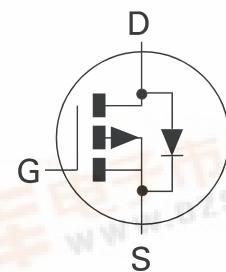
- Low on-resistance
- Fast switching speed
- Low threshold
- Low gate drive
- Low profile SOIC package

APPLICATIONS

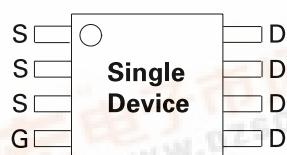
- Disconnect switches
- Motor control

ORDERING INFORMATION

DEVICE	REEL SIZE	TAPE WIDTH	QUANTITY PER REEL
ZXMP3A16N8TA	7"	12mm	500 units
ZXMP3A16N8TC	13"	12mm	2500 units



PINOUT



Top View

DEVICE MARKING

- ZXMP
3A16

ZXMP3A16N8

ABSOLUTE MAXIMUM RATINGS.

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V_{DSS}	-30	V
Gate Source Voltage	V_{GS}	± 20	V
Continuous Drain Current $V_{GS}=-10V$; $T_A=25^\circ C$ (b) $V_{GS}=-10V$; $T_A=70^\circ C$ (b) $V_{GS}=-10V$; $T_A=25^\circ C$ (a)	I_D	-6.7 -5.4 -5.6	A
Pulsed Drain Current (c)	I_{DM}	-26	A
Continuous Source Current (Body Diode) (b)	I_S	-3.2	A
Pulsed Source Current (Body Diode) (c)	I_{SM}	-26	A
Power Dissipation at $T_A=25^\circ C$ (a) Linear Derating Factor	P_D	1.9 15.2	W mW/°C
Power Dissipation at $T_A=25^\circ C$ (b) Linear Derating Factor	P_D	2.8 22.4	W mW/°C
Operating and Storage Temperature Range	$T_j; T_{stg}$	-55 to +150	°C

THERMAL RESISTANCE

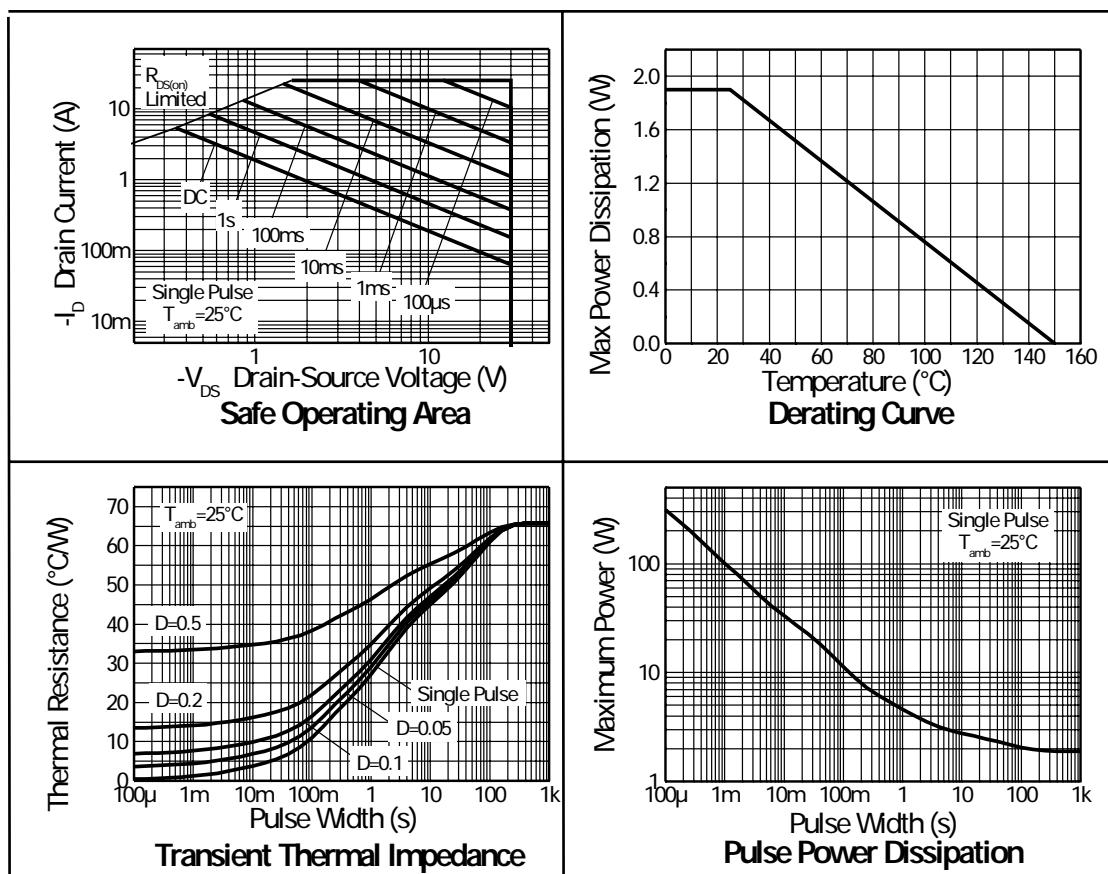
PARAMETER	SYMBOL	VALUE	UNIT
Junction to Ambient (a)	$R_{\theta JA}$	65	°C/W
Junction to Ambient (b)	$R_{\theta JA}$	45	°C/W

NOTES

- (a) For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions
- (b) For a device surface mounted on FR4 PCB measured at $t \leq 5$ secs.
- (c) Repetitive rating 25mm x 25mm FR4 PCB, $D = 0.05$, pulse width $10\mu s$ - pulse width limited by maximum junction temperature. Refer to Transient Thermal Impedance graph.

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CHARACTERISTICS



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ELECTRICAL CHARACTERISTICS (at $T_{amb} = 25^\circ C$ unless otherwise stated).

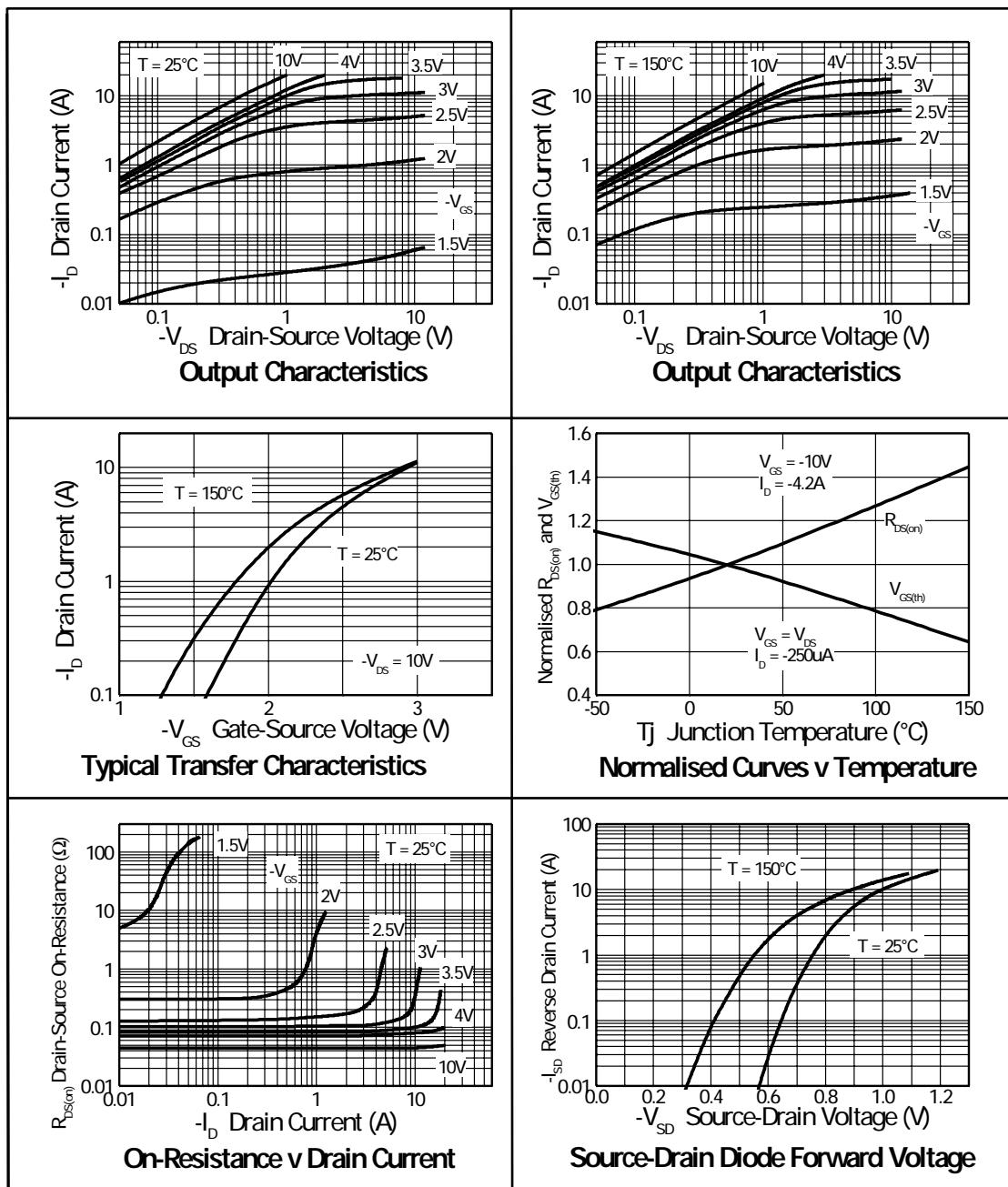
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS.
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	-30			V	$I_D=-250\mu A, V_{GS}=0V$
Zero Gate Voltage Drain Current	I_{DSS}			-1.0	μA	$V_{DS}=-30V, V_{GS}=0V$
Gate-Body Leakage	I_{GSS}			100	nA	$V_{GS}=\pm 20V, V_{DS}=0V$
Gate-Source Threshold Voltage	$V_{GS(th)}$	-1.0			V	$I_D=-250\mu A, V_{DS}= V_{GS}$
Static Drain-Source On-State Resistance (1)	$R_{DS(on)}$			0.040 0.070	Ω	$V_{GS}=-10V, I_D=-4.2A$ $V_{GS}=-4.5V, I_D=-3.4A$
Forward Transconductance (1)(3)	g_{fs}		9.2		S	$V_{DS}=-15V, I_D=-4.2A$
DYNAMIC (3)						
Input Capacitance	C_{iss}		970		pF	
Output Capacitance	C_{oss}		166		pF	$V_{DS}=-15V, V_{GS}=0V, f=1MHz$
Reverse Transfer Capacitance	C_{rss}		116		pF	
SWITCHING(2) (3)						
Turn-On Delay Time	$t_{d(on)}$		1.95		ns	
Rise Time	t_r		3.82		ns	$V_{DD}=-15V, I_D=-1A$
Turn-Off Delay Time	$t_{d(off)}$		31.8		ns	$R_G=6.0\Omega, V_{GS}=-10V$
Fall Time	t_f		10.2		ns	
Gate Charge	Q_g		12.9		nC	$V_{DS}=-15V, V_{GS}=-5V, I_D=-4.2A$
Total Gate Charge	Q_g		24.9		nC	
Gate-Source Charge	Q_{gs}		2.67		nC	$V_{DS}=-15V, V_{GS}=-10V, I_D=-4.2A$
Gate-Drain Charge	Q_{gd}		3.86		nC	
SOURCE-DRAIN DIODE						
Diode Forward Voltage (1)	V_{SD}		-0.85	-0.95	V	$T_J=25^\circ C, I_S=-3.6A, V_{GS}=0V$
Reverse Recovery Time (3)	t_{rr}		21.2		ns	$T_J=25^\circ C, I_F=-2A, dI/dt= 100A/\mu s$
Reverse Recovery Charge (3)	Q_{rr}		18.7		nC	

NOTES

- (1) Measured under pulsed conditions. Width $\leq 300\mu s$. Duty cycle $\leq 2\%$.
- (2) Switching characteristics are independent of operating junction temperature.
- (3) For design aid only, not subject to production testing.

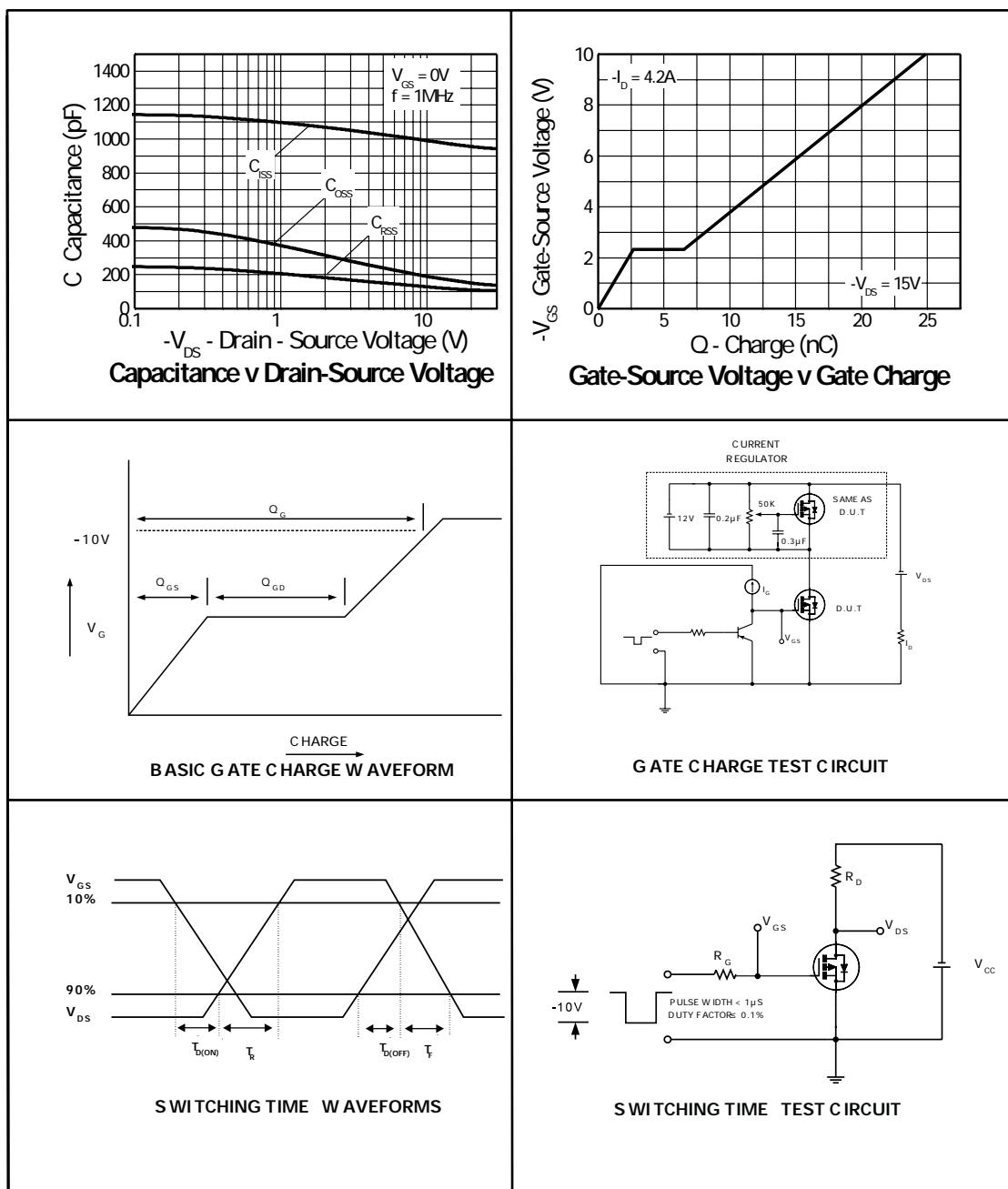
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CHARACTERISTICS



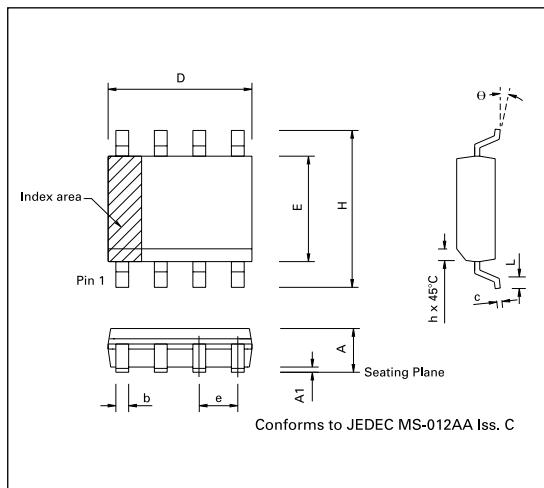
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CHARACTERISTICS



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PACKAGE OUTLINE



CONTROLLING DIMENSIONS ARE IN INCHES
APPROX IN MILLIMETRES

PACKAGE DIMENSIONS

DIM	INCHES		MILLIMETRES	
	MIN	MAX	MIN	MAX
A	0.053	0.069	1.35	1.75
A1	0.004	0.010	0.10	0.25
D	0.189	0.197	4.80	5.00
H	0.228	0.244	5.80	6.20
E	0.150	0.157	3.80	4.00
L	0.016	0.050	0.40	1.27
e	0.050 BSC		1.27 BSC	
b	0.013	0.020	0.33	0.51
c	0.008	0.010	0.19	0.25
θ	0°	8°	0°	8°
h	0.010	0.020	0.25	0.50

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PROVISIONAL ISSUE A - JULY 2002